

# **KSA1156**

# High Voltage Switching Low Power Switching Regulator DC-DC Converter

- High Breakdown Voltage
- Low Collector Saturation Voltage
- High Speed Switching



### **PNP Silicon Transistor**

### Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V <sub>CBO</sub>	Collector-Base Voltage	- 400	V
V <sub>CEO</sub>	Collector-Emitter Voltage	- 400	V
V <sub>EBO</sub>	Emitter-Base Voltage	- 7	V
В	Base Current	- 0.25	А
С	Collector Current (DC)	- 0.5	A
СР	Collector Current (Pulse)	- 1	A
°c	Collector Dissipation (T <sub>a</sub> =25°C)	1	W
°C	Collector Dissipation (T <sub>C</sub> =25°C)	10	W
Τ <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	- 55 ~ 150	°C

# Electrical Characteristics T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
V <sub>CEO</sub> (sus)	Collector-Emitter Sustaining Voltage	I <sub>C</sub> = - 100mA, I <sub>B</sub> = - 10mA L = - 20mH	- 400		V
V <sub>CEX</sub> (sus)	Collector-Emitter Sustaining Voltage	$I_C = -200 \text{mA}, I_{B1} = -I_{B2} = -20 \text{mA}$ $V_{BE}(\text{off}) = 5 \text{V}, L = 10 \text{mH}$	- 400		V
I <sub>CBO</sub>	Collector Cut-off Current	V <sub>CB</sub> = - 400V, I <sub>E</sub> = 0		- 100	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	V <sub>EB</sub> = - 5V, I <sub>C</sub> = 0		- 10	μΑ
I <sub>CEX1</sub>	Collector Cut-off Current	$V_{CE} = -400V, V_{BE}(off) = 1.5V$	A MA	- 100	μΑ
I <sub>CEX2</sub>	Collector Cut-off Current	$V_{CE} = -400V, V_{BE}(off) = 1.5V$ $T_{C} = 125^{\circ}C$		- 1	mA
h <sub>FE</sub>	DC Current Gain	V <sub>CE</sub> = - 5V, I <sub>C</sub> = - 100mA	30	200	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> = - 100mA, I <sub>B</sub> = - 10mA		- 1	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	I <sub>C</sub> = - 100mA, I <sub>B</sub> = - 10mA		- 1.2	V
t <sub>ON</sub>	Turn On Time	V <sub>CC</sub> = - 150V, I <sub>C</sub> = - 100mA		1	μs
t <sub>STG</sub>	Storage Time	$I_{B1} = -10 \text{mA}$ , $I_{B2} = 20 \text{mA}$		4	μs
t <sub>F</sub>	Fall Time	$R_L = 1.5K\Omega$		1	μs

# **h**<sub>FF</sub> Classification

· <del>-</del>					
Classification	N	R	0	Y	
PDF h <sub>FE</sub>	30 ~ 60	40 ~ 80	60 ~ 120	100 ~ 200	

# **Typical Characteristics**

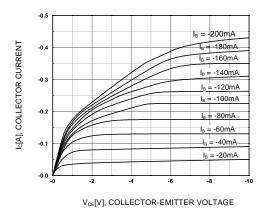


Figure 1. Static Characteristic

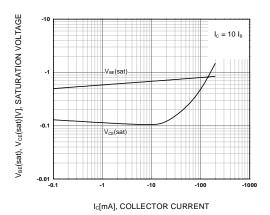


Figure 3. Collector-Emitter Saturation Voltage
Base-Emitter Saturation Voltage

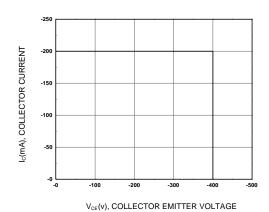


Figure 5. Reverse Bias Safe Operating Area

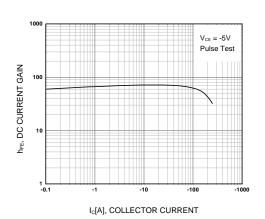


Figure 2. DC current Gain

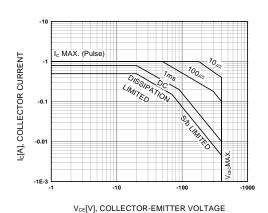


Figure 4. Safe Operating Area

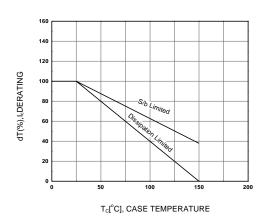


Figure 6. Derating Curve of Safe Operating Areas

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# Typical characteristics (Continued)

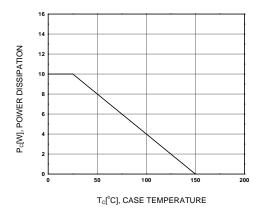
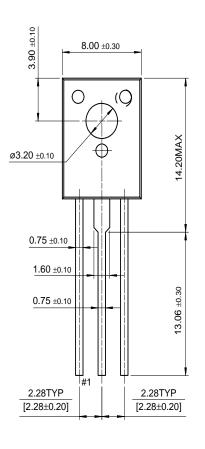


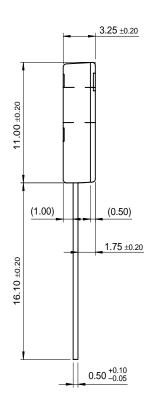
Figure 7. Power Derating

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# **Package Demensions**

TO-126







Dimensions in Millimeters

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FAST® Quiet Series $^{TM}$  SuperSOT $^{TM}$ -3 SuperSOT $^{TM}$ -6

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